

MOSFET

OptiMOS[™] 3 Power-Transistor, 250 V

Features

- Ideal for high frequency switching and sync. rec.
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 N-channel, normal level

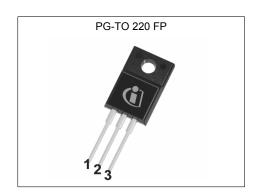
- 100% avalanche tested
- Pb-free plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

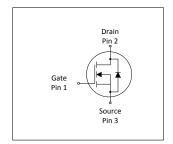
Product validation

Qualified according to JEDEC Standard

Kev Performance Parameters Table 1

| Parameter | Value | Unit |
|-------------------------|-------|------|
| $V_{	extsf{DS}}$ | 250 | V |
| R _{DS(on),max} | 60 | mΩ |
| I _D | 15 | A |
| Qoss | 46 | nC |
| Q _G (0V10V) | 22 | nC |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|-------------------|----------|---------------|
| IPA600N25NM3S | PG-TO 220 FullPAK | 600N253S | - |

OptiMOS[™] 3 Power-Transistor, 250 V



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OptiMOS[™] 3 Power-Transistor, 250 V IPA600N25NM3S



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Maximum ratings Table 2

| Parameter | 0 b a l | Values | | | 1114 | Note / Tool Constition |
|----------------------------------------------|-----------------------------------|--------|------|----------|------|-----------------------------------------------------------------------------------------------|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Continuous drain current | ID | - | - | 15 10 | А | V _{GS} =10 V, T _C =25 °C V _{GS} =10 V, T _C =100 °C |
| Pulsed drain current ¹⁾ | I _{D,pulse} | - | - | 60 | Α | <i>T</i> _C =25 °C |
| Avalanche energy, single pulse ²⁾ | E _{AS} | - | - | 210 | mJ | $I_{\rm D}$ =15 A, $R_{\rm GS}$ =25 Ω |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - |
| Power dissipation | P _{tot} | - | - | 38 | W | T _C =25 °C |
| Operating and storage temperature | T _j , T _{stg} | -55 | - | 175 | °C | IEC climatic category; DIN IEC 68-1: 55/175/56 |

2 Thermal characteristics

Table 3 Thermal characteristics

| Doromotor | Symbol | Values | | | 11 | Nata / Tank Canadition | |
|-------------------------------------|-------------------|--------|------|------|------|------------------------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Thermal resistance, junction - case | R _{thJC} | - | - | 3.9 | °C/W | - | |

3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

| Parameter | Crumb al | | Values | | | Note / Took Condition |
|----------------------------------|-----------------------|------|-----------|----------|------|---------------------------------------------------------------------------------------------------------------------------------------------|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Drain-source breakdown voltage | V _{(BR)DSS} | 250 | - | - | V | $V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA |
| Gate threshold voltage | V _{GS(th)} | 2 | - | 4 | V | $V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =89 $\mu {\rm A}$ |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 1 100 | μA | V _{DS} =200 V, V _{GS} =0 V, T _j =25 °C V _{DS} =200 V, V _{GS} =0 V, T _j =125 °C |
| Gate-source leakage current | I _{GSS} | - | 1 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V |
| Drain-source on-state resistance | R _{DS(on)} | - | 49.0 | 60.0 | mΩ | V _{GS} =10 V, I _D =15 A |
| Gate resistance ³⁾ | R _G | - | 2.5 | - | Ω | - |
| Transconductance | g fs | - | 37 | - | S | $ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 15 A$ |

See Diagram 3 for more detailed information
 See Diagram 13 for more detailed information
 Defined by design. Not subject to production test.

OptiMOS[™] 3 Power-Transistor, 250 V IPA600N25NM3S



Table 5 Dynamic characteristics

| Parameter | Crossbal | Values | | | 11 | Nata / Tast Candition |
|---------------------------------|------------------|--------|------|------|------|-------------------------------------------------------------------------------------------|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Input capacitance ¹⁾ | C _{iss} | - | 1800 | 2300 | pF | V _{GS} =0 V, V _{DS} =100 V, f=1 MHz |
| Output capacitance | Coss | - | 110 | - | pF | V _{GS} =0 V, V _{DS} =100 V, f=1 MHz |
| Reverse transfer capacitance | C _{rss} | - | 5 | - | pF | V _{GS} =0 V, V _{DS} =100 V, f=1 MHz |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 10 | - | ns | $V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =12 A, $R_{\rm G,ext}$ =1.6 Ω |
| Rise time | t _r | - | 10 | - | ns | $V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =12 A, $R_{\rm G,ext}$ =1.6 Ω |
| Turn-off delay time | $t_{ m d(off)}$ | - | 22 | - | ns | $V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =12 A, $R_{\rm G,ext}$ =1.6 Ω |
| Fall time | t _f | - | 8 | - | ns | $V_{\rm DD}$ =100 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =12 A, $R_{\rm G,ext}$ =1.6 Ω |

Table 6 Gate charge characteristics²⁾

| Parameter | Ob. a.l. | | Values | | | Nata (Table Operation |
|---------------------------------|----------------------|------|--------|------|------|-----------------------------------------------------------------|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Gate to source charge | Q _{gs} | - | 8 | - | nC | $V_{\rm DD}$ =100 V, $I_{\rm D}$ =12 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge at threshold | Q _{g(th)} | - | 5 | - | nC | V_{DD} =100 V, I_{D} =12 A, V_{GS} =0 to 10 V |
| Gate to drain charge | Q _{gd} | - | 3 | - | nC | V_{DD} =100 V, I_{D} =12 A, V_{GS} =0 to 10 V |
| Switching charge | Q _{sw} | - | 5 | - | nC | V_{DD} =100 V, I_{D} =12 A, V_{GS} =0 to 10 V |
| Gate charge total ¹⁾ | Qg | - | 22 | 29 | nC | V_{DD} =100 V, I_{D} =12 A, V_{GS} =0 to 10 V |
| Gate plateau voltage | V _{plateau} | - | 4.3 | - | V | V_{DD} =100 V, I_{D} =12 A, V_{GS} =0 to 10 V |
| Output charge | Qoss | - | 46 | - | nC | V _{DD} =100 V, V _{GS} =0 V |

Table 7 Reverse diode

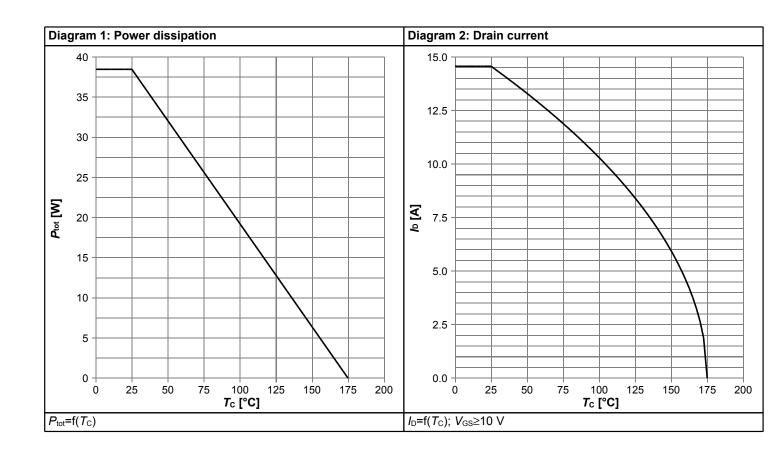
| Parameter | Cumbal | | Values | | | Note / Took Condition |
|---------------------------------------|----------------------|------|--------|------|------|--------------------------------------------------------------------------------------------|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Diode continuous forward current | Is | - | - | 15 | Α | <i>T</i> _C =25 °C |
| Diode pulse current | I _{S,pulse} | - | - | 60 | Α | <i>T</i> _C =25 °C |
| Diode forward voltage | V _{SD} | - | 0.87 | 1.2 | V | V _{GS} =0 V, I _F =15 A, T _j =25 °C |
| Reverse recovery time ¹⁾ | t _{rr} | - | 127 | - | ns | V _R =100 V, I _F =12 A, d <i>i</i> _F /d <i>t</i> =100 A/μs |
| Reverse recovery charge ¹⁾ | Q _{rr} | - | 604 | - | nC | V_{R} =100 V, I_{F} =12 A, di_{F}/dt =100 A/ μ s |

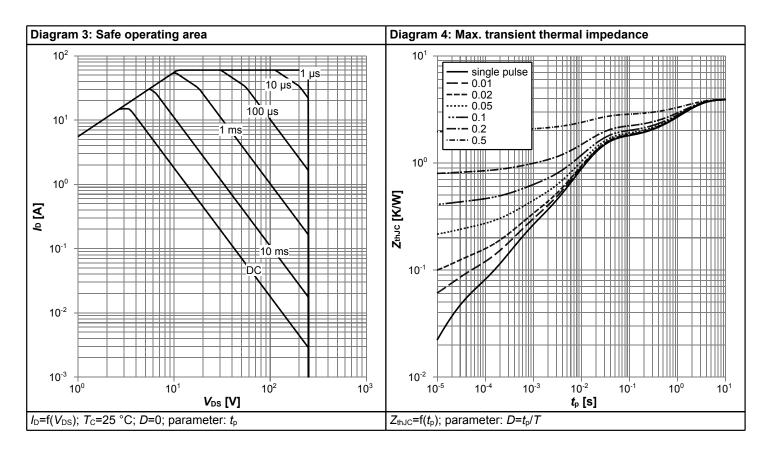
Final Data Sheet 4 Rev. 2.1, 2019-09-02

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

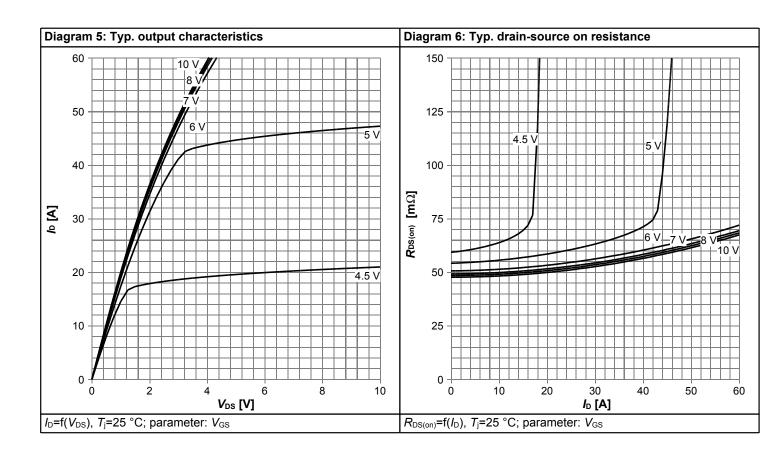


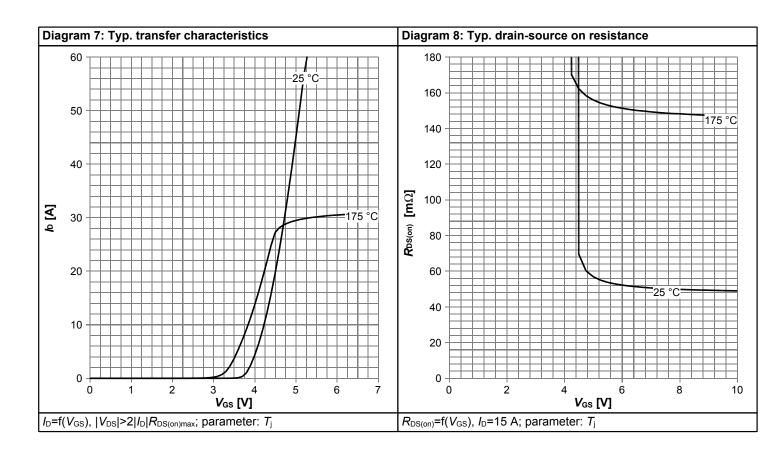
4 Electrical characteristics diagrams



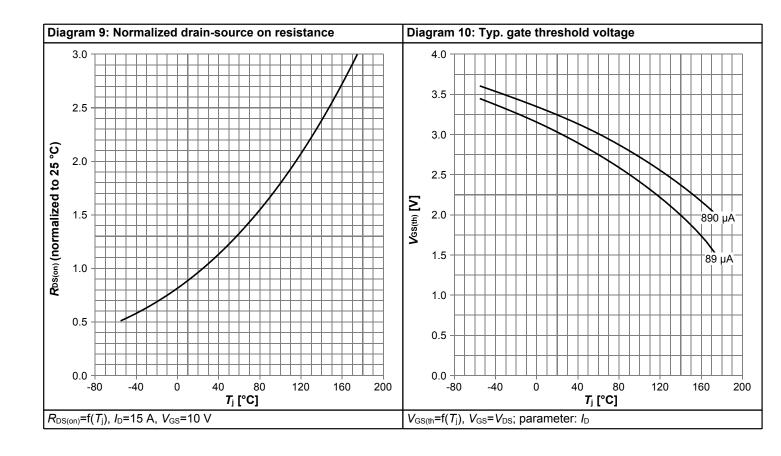


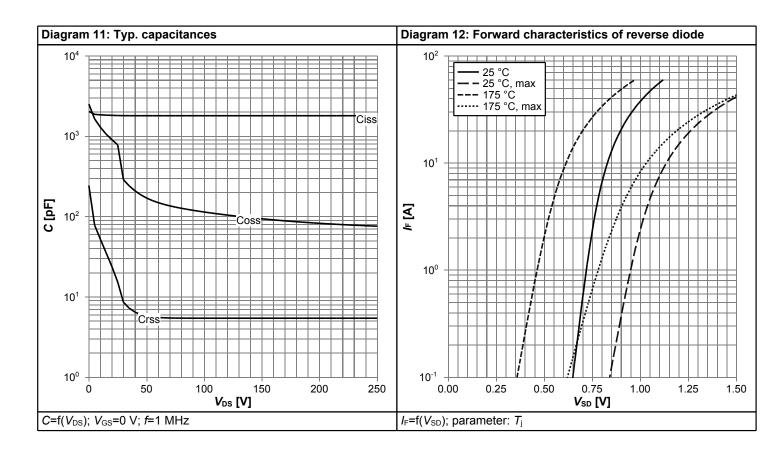




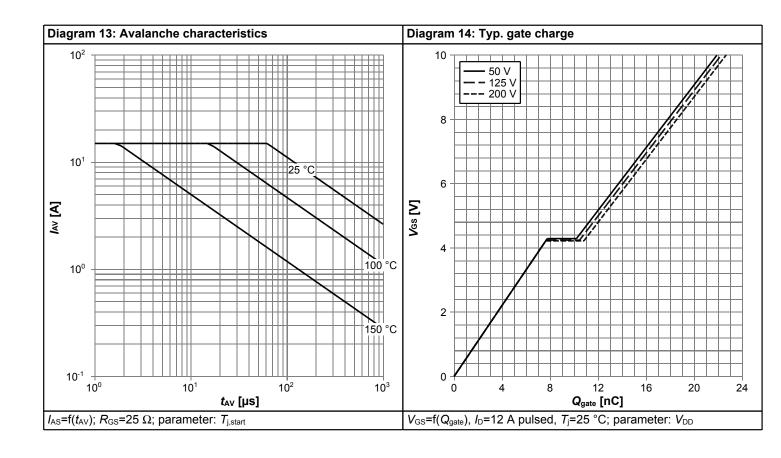


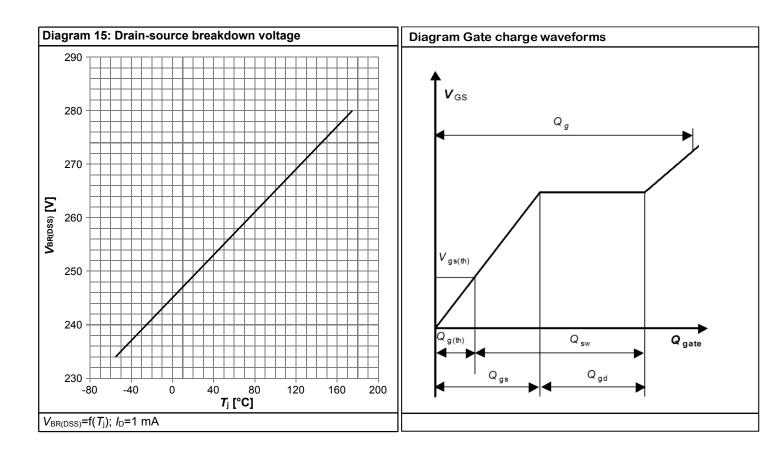














5 Package Outlines

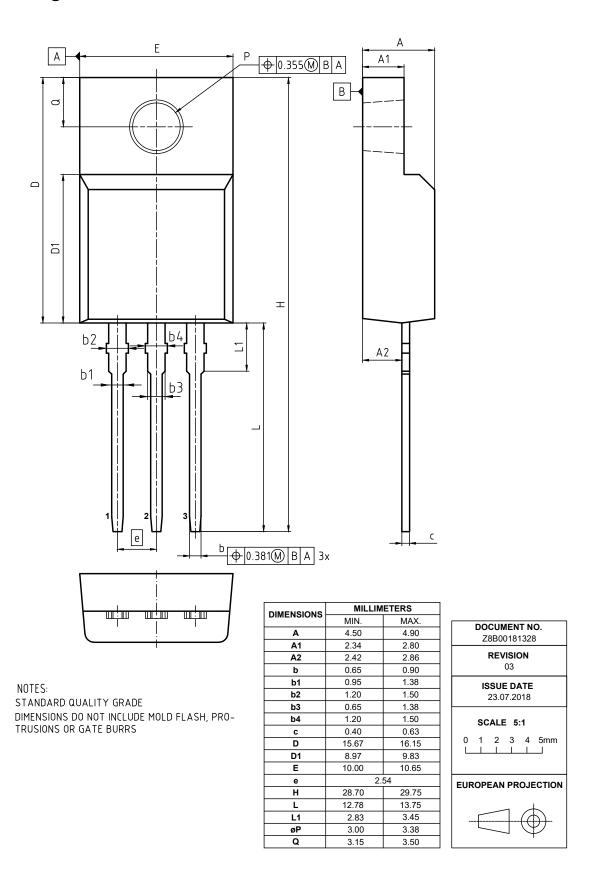


Figure 1 Outline PG-TO 220 FullPAK, dimensions in mm/inches

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Revision History

IPA600N25NM3S

Revision: 2019-09-02, Rev. 2.1

Previous Revision

| 1 10110401 | TOVICAGE NOVIGION | | | | | | | |
|------------|-------------------|----------------------------------------------|--|--|--|--|--|--|
| Revision | Date | Subjects (major changes since last revision) | | | | | | |
| 2.0 | 2019-07-25 | Release of final version | | | | | | |
| 2.1 | 2019-09-02 | Update package outline | | | | | | |

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